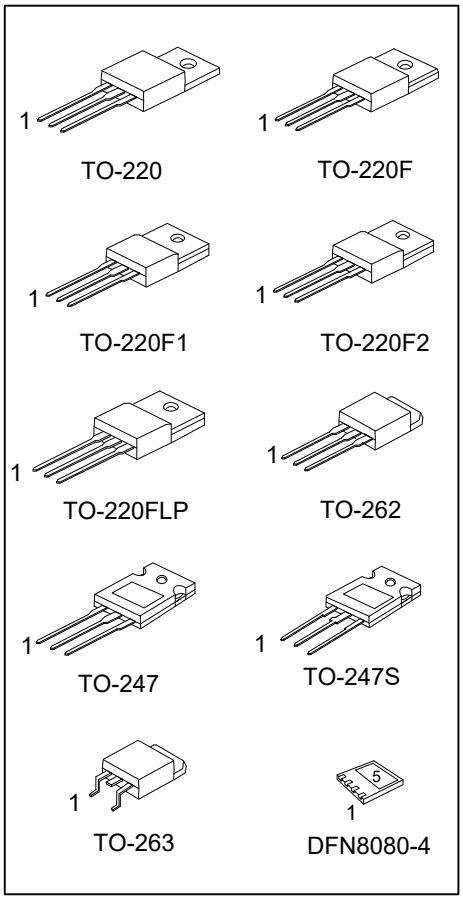
24A, 650V N-CHANNEL SUPER-JUNCTION MOSFET



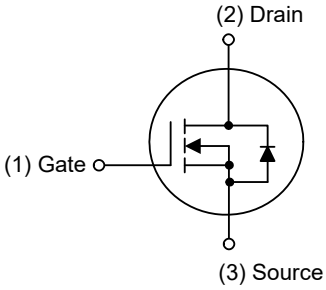
■ DESCRIPTION

The **UTC 24NM65** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

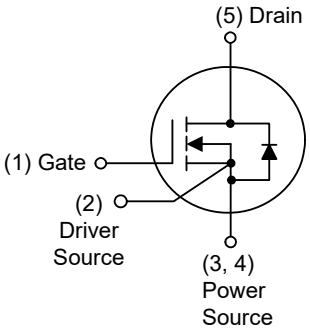
■ FEATURES

* For TO-220 / TO-220F / TO-220F1 / TO-220F2
  TO-220FLP / TO-247 / TO-247S / TO-262 / TO-263
  $R_{DS(ON)} \leq 0.16\ \Omega$ @ V_{GS}=10V, I_D=12A
  For DFN8080-4
  $R_{DS(ON)} \leq 0.18\ \Omega$ @ V_{GS}=10V, I_D=12A
* High Switching Speed
* 100% Avalanche Tested

■ SYMBOL



TO-220 / TO-220F / TO-220F1
TO-220F2 / TO-220FLP / TO-247
TO-247S / TO-262 / TO-263

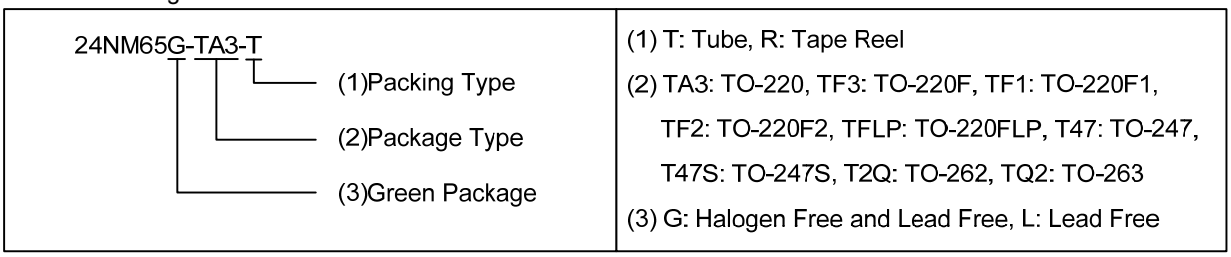


DFN8080-4

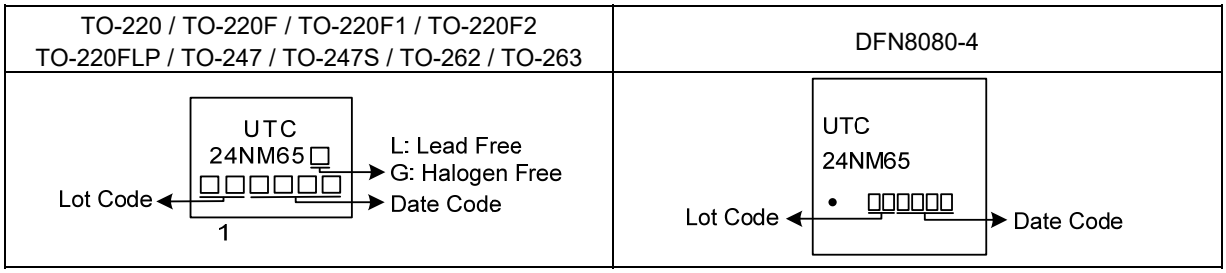
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment					Packing
Lead Free	Halogen Free		1	2	3	4	5	
24NM65L-TA3-T	24NM65G-TA3-T	TO-220	G	D	S	-	-	Tube
24NM65L-TF1-T	24NM65G-TF1-T	TO-220F1	G	D	S	-	-	Tube
24NM65L-TF2-T	24NM65G-TF2-T	TO-220F2	G	D	S	-	-	Tube
24NM65L-TF3-T	24NM65G-TF3-T	TO-220F	G	D	S	-	-	Tube
24NM65G-TFLP-T	24NM65G-TFLP-T	TO-220FLP	G	D	S	-	-	Tube
24NM65L-T47-T	24NM65G-T47-T	TO-247	G	D	S	-	-	Tube
24NM65L-T47S-T	24NM65G-T47S-T	TO-247S	G	D	S	-	-	Tube
24NM65L-T2Q-T	24NM65G-T2Q-T	TO-262	G	D	S	-	-	Tube
24NM65L-TQ2-T	24NM65G-TQ2-T	TO-263	G	D	S	-	-	Tube
24NM65L-TQ2-R	24NM65G-TQ2-R	TO-263	G	D	S	-	-	Tape Reel
24NM65L-K04-8080-R	24NM65G-K04-8080-R	DFN8080-4	G	S	S	S	D	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source



■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V_{DSS}	650	V
Gate-Source Voltage			V_{GSS}	±30	V
Drain Current	Continuous	T_C=25°C	I_D	24	A
		T_C=100°C		14.4	
	Pulsed (Note 2)		I_{DM}	72	A
Avalanche Energy	Single Pulsed (Note 3)		E_{AS}	725	mJ
Peak Diode Recovery dv/dt			dv/dt	10.5	V/ns
Power Dissipation	TO-220/TO-262 TO-263		P_D	130	W
	TO-220F/TO-220F1 TO-220F2/TO-220FLP			35	W
	TO-247/TO-247S			150	W
	DFN8080-4			67	W
Junction Temperature			T_J	+150	°C
Storage Temperature			T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L = 58mH, I_{AS} = 5.0A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
4. I_{SD} ≤ 24A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220FLP/TO-262 TO-263	θ_{JA}	62.5	°C/W
	DFN8080-4		35 (Note)	°C/W
	TO-247/TO-247S		50	°C/W
Junction to Case	TO-220/TO-262 TO-263	θ_{JC}	0.96	°C/W
	TO-220F/TO-220F1 TO-220F2/TO-220FLP		3.57	°C/W
	TO-247/TO-247S		0.83	°C/W
	DFN8080-4		1.86 (Note)	°C/W

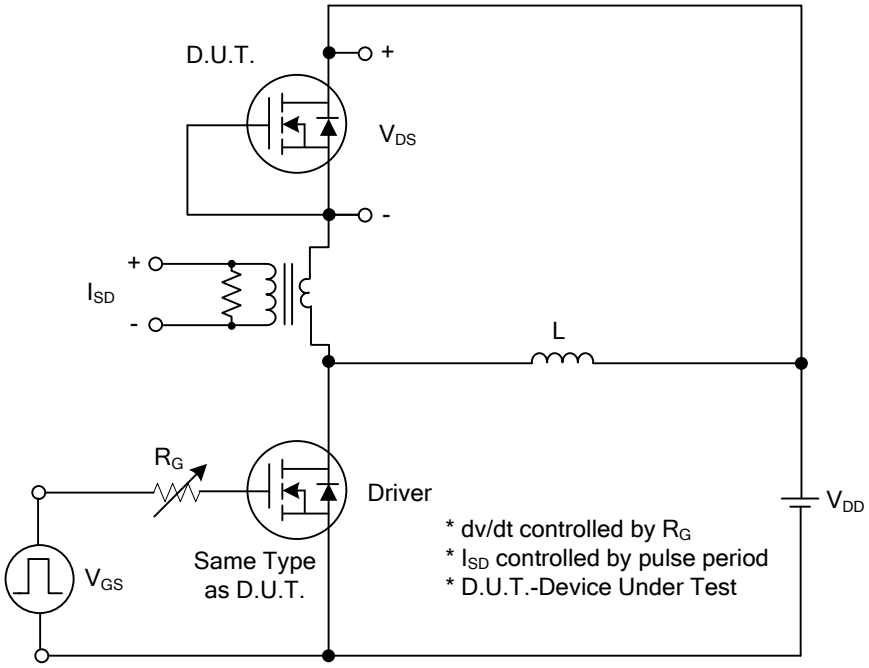
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

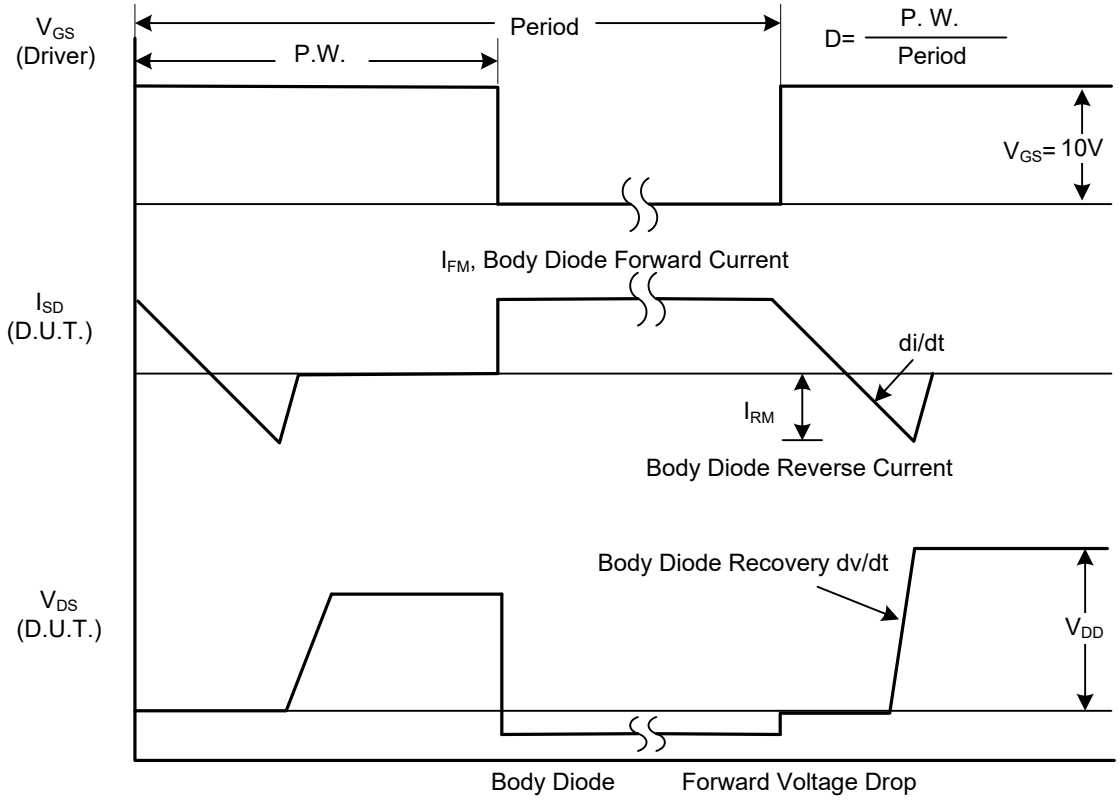
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	650			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=650V, V_{GS}=0V			50	μA
Gate- Source Leakage Current	Forward	I_{GSS}	V_{GS}=+30V, V_{DS}=0V			+100	nA
	Reverse		V_{GS}=-30V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	2.5		4.5	V
Static Drain-Source On-State Resistance	TO-220/TO-220F TO-220F1 TO-220F2 TO-220FLP TO-247/TO-247S TO-262/TO-263	$R_{DS(ON)}$	V_{GS}=10V, I_D=12A			0.16	Ω
	DFN8080-4					0.18	Ω
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=50V, f=1.0MHz		1924		pF
Output Capacitance		C_{OSS}			220		pF
Reverse Transfer Capacitance		C_{RSS}			7.8		pF
SWITCHING PARAMETERS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=520V, V_{GS}=10V, I_D=24A (Note1, 2)		66		nC
Gate to Source Charge		Q_{GS}			10		nC
Gate to Drain Charge		Q_{GD}			22		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V_{DS}=100V, V_{GS}=10V, I_D=24A, R_G=25Ω (Note1, 2)		28		ns
Rise Time		t_R			36		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			240		ns
Fall-Time		t_F			120		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				24	A
Maximum Body-Diode Pulsed Current		I_{SM}				72	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S=24A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	I_S=24A, V_{GS}=0V, dI_F/dt=100A/μs		640		ns
Body Diode Reverse Recovery Charge		Q_{rr}			13		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating ambient temperature.

■ TEST CIRCUITS AND WAVEFORMS



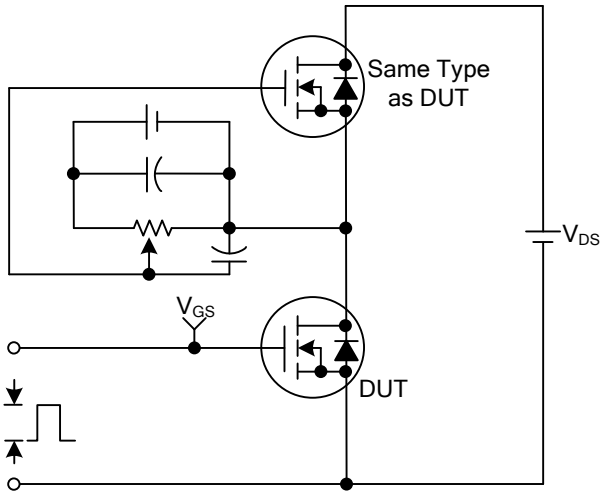
Peak Diode Recovery dv/dt Test Circuit



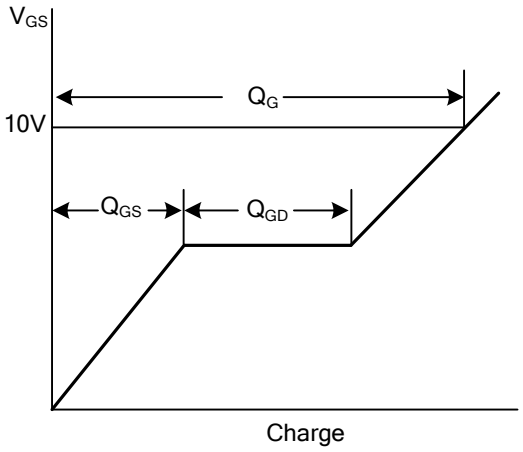
Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS

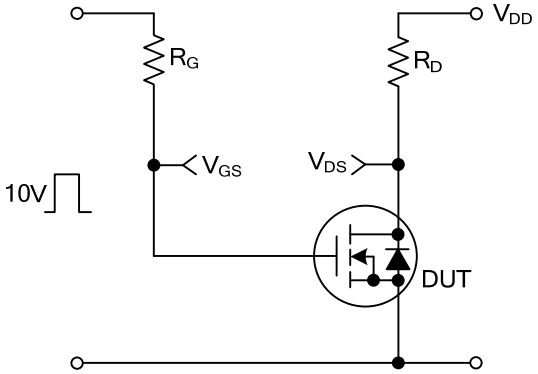
Gate Charge Test Circuit



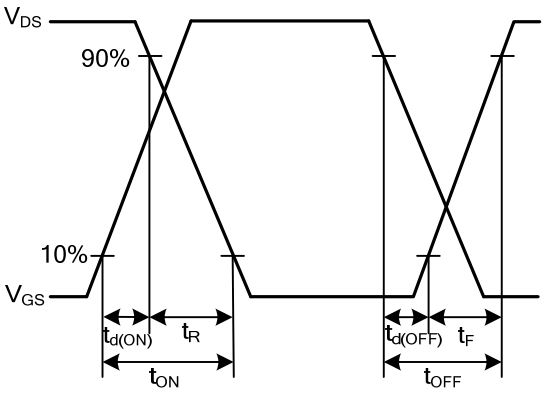
Gate Charge Waveforms



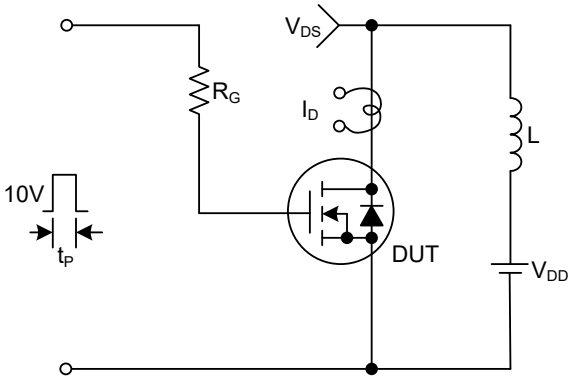
Resistive Switching Test Circuit



Resistive Switching Waveforms

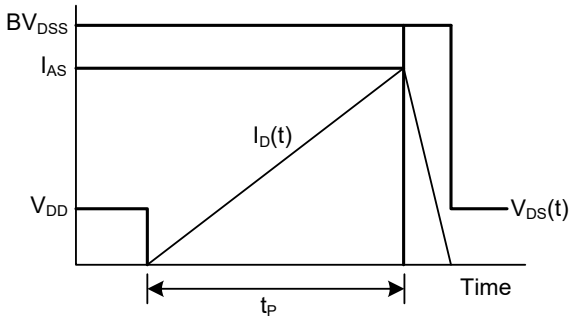


Unclamped Inductive Switching Test Circuit



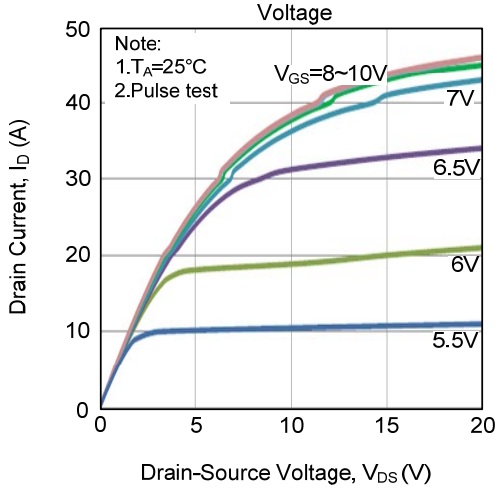
Unclamped Inductive Switching Waveforms

$$E_{AS}=\frac{1}{2}LI_{AS}^{2}\frac{BV_{DSS}}{BV_{DSS}-V_{DD}}$$

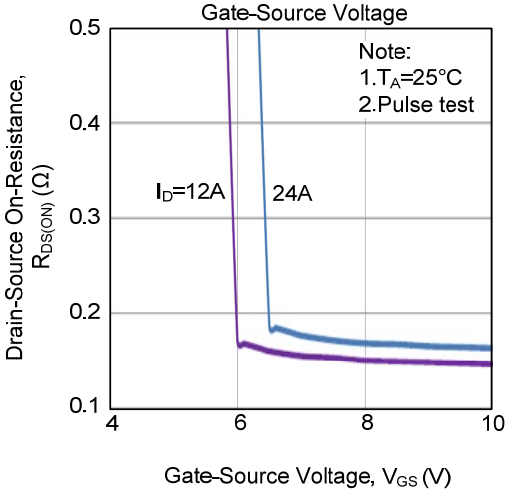


■ TYPICAL CHARACTERISTICS

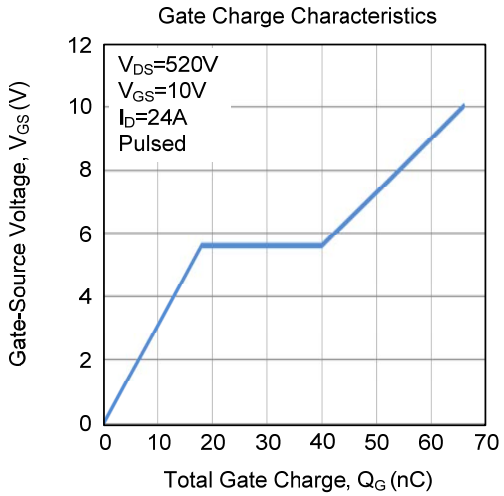
Drain Current vs. Drain-Source Voltage



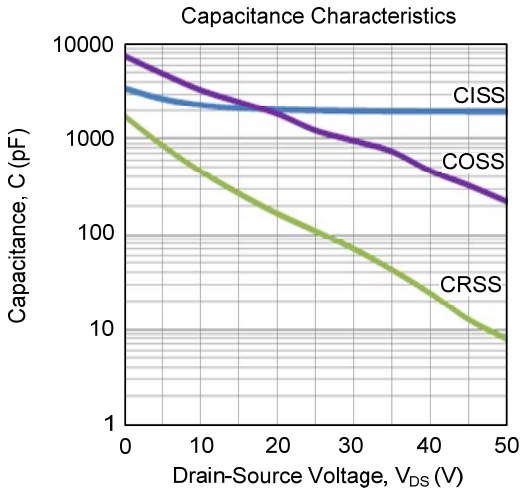
Drain-Source On-Resistance vs. Gate-Source Voltage



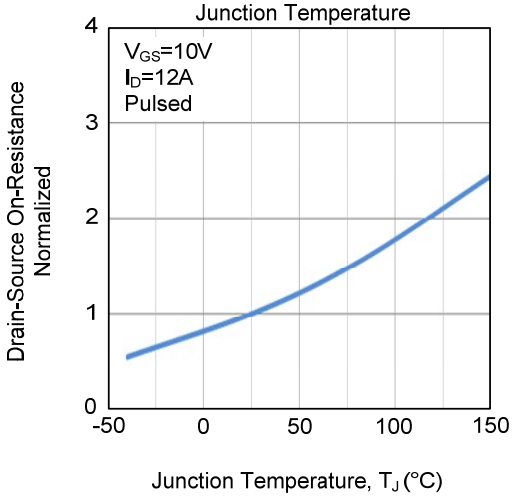
Gate Charge Characteristics



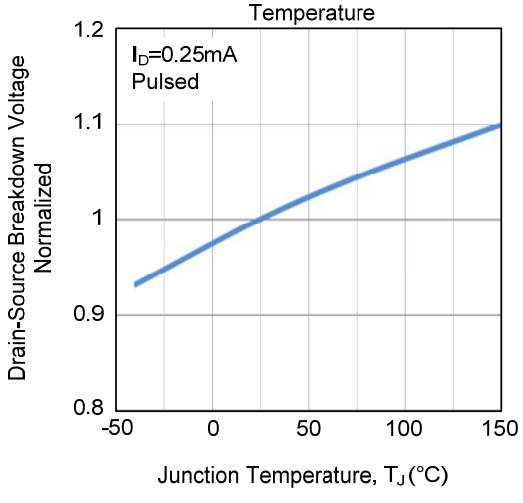
Capacitance Characteristics



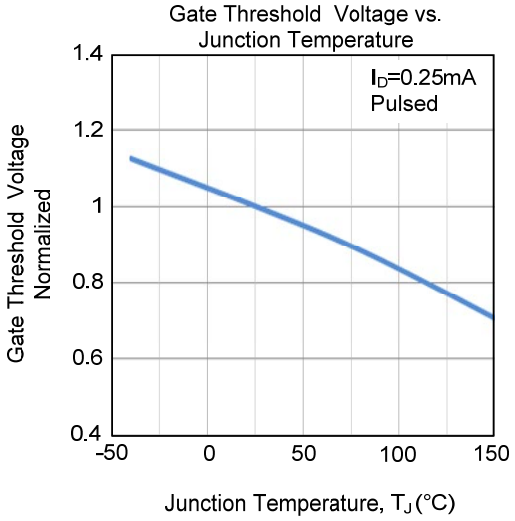
Drain-Source On-Resistance vs. Junction Temperature

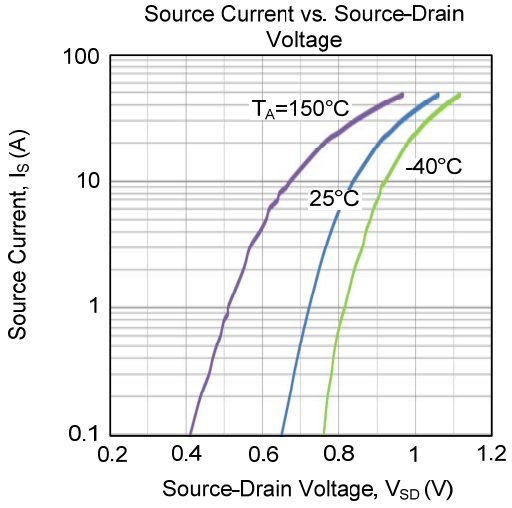


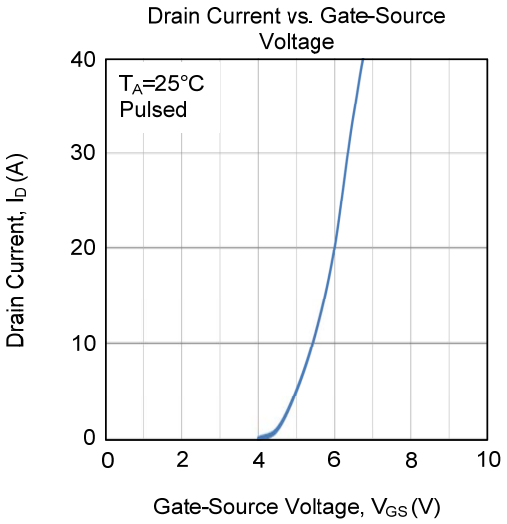
Breakdown Voltage vs. Junction Temperature

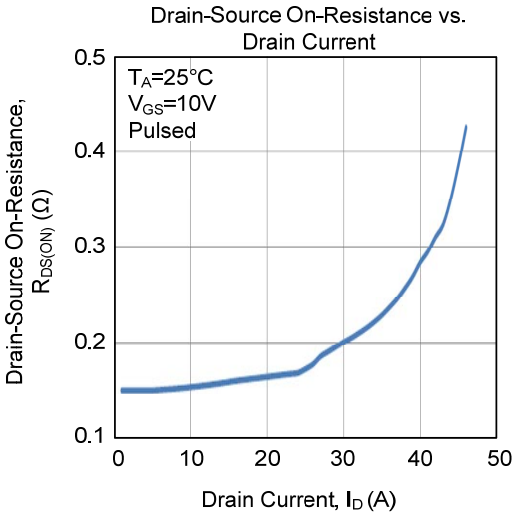


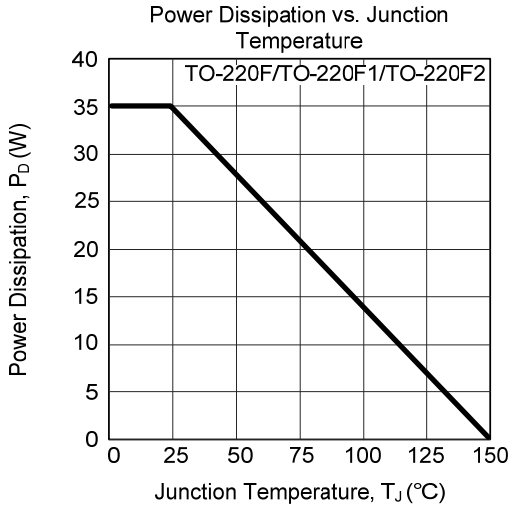
■ TYPICAL CHARACTERISTICS (Cont.)

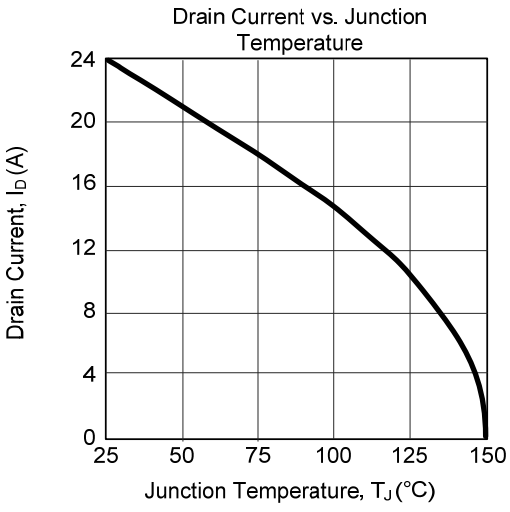












■ TYPICAL CHARACTERISTICS (Cont.)